

TEST AND SIMULATE ELECTRICAL INTERFACES FOR SPACECRAFT

The **Multi-Purpose Interface Platform (MPIP)** is a **modular, scalable** electrical ground support equipment (EGSE) that enables test and simulation of **electrical interfaces** for spacecraft in a fast, flexible and cost-efficient manner.

The MPIP can combine a large variety of interfaces into a single platform, and is scalable to the customer needs. In total, the system can provide **up to 400 ECSS compliant interfaces**.



The MPIP supports **up to 16 interface modules** fitted onto a backplane. Each module represents a dedicated electrical interface type and all modules can run simultaneously.

Each MPIP is equipped with the MPIP Controller Module (MCM).

The MCM provides status and control for the equipped interface modules (i.e. through a GUI running on a User Workstation). The module also includes isolated interface circuitry for medium data rate applications up to 800Mbps, and can act as an interface module itself. It provides interfaces such as standard RS422/RS485/LVDS, SpaceWire, SERDES and Parallel/Serial LVDS.

KEY FEATURES

General

- 2U or 4U 19" rack mountable or tabletop chassis
- Supports up to 16 interface modules of any type and combination
- Discrete TM/TC, Power and Digital Data Interfaces
- Custom interfaces and protocol support
- 2x Gigabit Ethernet ports for Control and Data via TCP/IP (RJ45)
- PPS/Trigger output for synchronization of external equipment
- External Time inputs, such as PPS and IRIG
- In-field upgradable

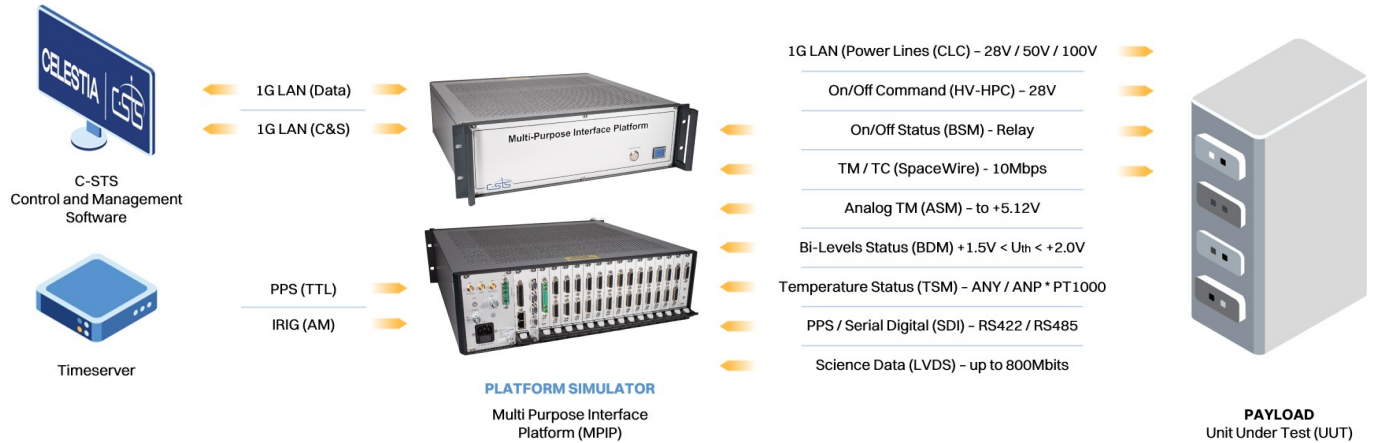
Interface Modules

- 19x Different pluggable module types available
- Up to two different bus voltage inputs for LCL and Heater Interfaces
- All interfaces to/from UUT are galvanically isolated
- FMEA Report available for all interface modules
- Fully compliant interfaces with ESA/ECSS standards

Software Support

- Graphical User Interface
- Local scripting using Python
- Logging and archiving
- Remote Control via EDEN, C&C, RPC, etc.

MULTI-PURPOSE INTERFACE PLATFORM



The MPIP is a versatile system that can be used to test and/or simulate electrical interfaces of spacecraft sub-systems such as:

- On-Board Computers (OBC)
- Power Conditioning Units (PCDU)
- Instrument Control Units (ICU)
- Payload and Platform Elements

NEW INTERFACE MODULES COMING IN 2024

- WizardLink (up to 2.5Gbps)
- SpaceFibre (up to 6.25Gbps)
- Custom FPGA Transceiver (up to 12.5Gbps)

LIST OF MPIP INTERFACE MODULES AVAILABLE TODAY

| Interface Type | Function or Protocol | I/O per Card | Direction | Basic Specifications |
|---|-------------------------------------|--------------|-------------|-------------------------------------|
| Latching Current Limiter - LCL | Latching Current Limiter | 2 | Output | 28V, 50V, 100V, Class 0.5A to 20A |
| Heater Latching Current Limiter - HLCL | Heater Latching Current Limiter | 12 | Output | 28V, 50V, 100V, 4A per output |
| Secondary Level Protection Module - SLP | Secondary Level Protection | 1 | Output | 28V, 50V, 100V, UVP/OVP/OCP, <2μs |
| Analogue Signal Monitor - Simulation | Digital to Analog Converter | 24 | Output | 16-Bit DAC, ≤2 LSBs |
| Analogue Signal Monitor - Acquisition | Analog to Digital Converter | 24 | Input | 16-Bit ADC, ≤2 LSBs |
| Temperature Sensor Monitor - Simulation | Digital Rheostat | 24 | Output | 0Ω to 1MΩ, 0.1% |
| Temperature Sensor Monitor - Acquisition | Analog to Digital Converter | 24 | Input | 16-Bit ADC, ≤2 LSBs |
| Bi-Level Discrete Monitor - Simulation | Digital to Analog Converter | 24 | Output | 0V to +5V |
| Bi-Level Discrete Monitor - Acquisition | Analog to Digital Converter | 24 | Input | 0V to +5V |
| Bi-Level Switch Monitor - Simulation | Relay/Switch | 24 | Output | ≤ 50Ω and ≥ 1MΩ |
| Bi-Level Switch Monitor - Acquisition | Analog to Digital Converter | 24 | Input | 0V to +5V |
| High-Power Command - Simulation | Low-, High-voltage and High-Current | 24 | Output | +12V to +29V, 4ms to 1024ms |
| High-Power Command - Acquisition | Low-, High-voltage and High-Current | 24 | Input | +11V to +29V, ≥100us |
| Low-Power Command - Simulation | Low Power Pulsed or Bi-Level | 24 | Output | 0V to +5V, 4ms to 120ms |
| Low-Power Command - Acquisition | Low Power Pulsed or Bi-Level (opto) | 24 | Input | 0V to +5V, ≥100us |
| Serial Digital Interfaces - Bi-directional | RS-422, RS485 or LVDS | 20 / 40 / 60 | In & Output | Standard & custom protocols/signals |
| SpaceWire Interfaces - Bi-directional | SpaceWire (LVDS) | 4 | In & Output | Up to 200Mbps per channel |
| Parallel LVDS Interfaces - Bi-directional | Parallel LVDS | 2 | In & Output | Up to 400Mbps per channel |
| Serialiser/Deserialiser Interfaces - SERDES | LVDS217/LVDS218 | 1 / 1 | In & Output | Up to 800Mbps (Tx and Rx) |

